

**TRANSMITTAL**

Electronic Version v1.1

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<b>Title of Invention</b>	<b>BONDING PAD AND CHIP STRUCTURE</b>							
<p>Application Number : Date : First Named Applicant: Mr. Chiu-Shun Lin Confirmation Number: Attorney Docket Number: 13689-US-PA</p>								
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<table border="1"><thead><tr><th data-bbox="83 622 493 646">Submitted By:</th><th data-bbox="493 622 707 646">Elec. Sign.</th><th data-bbox="707 622 901 646">Sign. Capacity</th></tr></thead><tbody><tr><td data-bbox="83 646 493 694">Dr. Belinda Lee Registered Number: 46863</td><td data-bbox="493 646 707 694">/Belinda Lee/</td><td data-bbox="707 646 901 694">Agent</td></tr></tbody></table>			Submitted By:	Elec. Sign.	Sign. Capacity	Dr. Belinda Lee Registered Number: 46863	/Belinda Lee/	Agent
Submitted By:	Elec. Sign.	Sign. Capacity						
Dr. Belinda Lee Registered Number: 46863	/Belinda Lee/	Agent						

Documents being submitted:	Files
us-assignment	13689-usassn.xml us-assignment.xsl us-assignment.dtd 13689assignment01.tif 13689assignment02.tif
us-request	13689-usrequ.xml us-request.dtd us-request.xsl
us-fee-sheet	13689-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd
us-declaration	13689declaration01.tif
application-body	13689usf.xml application-body.dtd Image1.tif Image2.tif Image3.tif Image4.tif isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isogr1.ent isogr2.ent isogr3.ent isogr4.ent isolat1.ent isolat2.ent isomfrk.ent isomopf.ent isomscr.ent isonum.ent isopub.ent isotech.ent mathml2.dtd mathml2-qname-1.mod mmlalias.ent mmlextra.ent soextblx.dtd us-application-body.xsl wipo.ent
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abstract-pdf	13689usf-abst.pdf

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us-declaration	13689declaration02.tif
<b>Comments</b>	
<p>Please be kindly advised that the indicated fee of this EFS application is intended to be paid by credit card. However, in the event that the payment through credit card is unsuccessful, the Commissioner is authorized to charge the required fee in connection with this application to Deposit Account No. 50-2620(Order No.13689-US-PA). Deposit Account Name: Jiang Chyun Intellectual Property Office, Authorized User Name: Belinda Lee, E-mail: Belinda@jcipgroup.com.tw; usa@jcipgroup.com.tw</p>	